

N-Channel Enhancement Mode MOSFET

1. Product Information

1.1 Features

- | | |
|---|---|
| <input checked="" type="checkbox"/> Surface-mounted package | <input checked="" type="checkbox"/> Low thermal impedance |
| <input checked="" type="checkbox"/> Low $R_{DS(ON)}$ | <input checked="" type="checkbox"/> 100% avalanche tested |

1.2 Applications

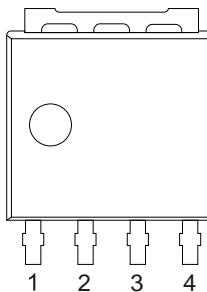
- | | |
|---|--|
| <input checked="" type="checkbox"/> Motor drives | <input checked="" type="checkbox"/> DC/DC conversion |
| <input checked="" type="checkbox"/> Synchronous rectifier | |

1.3 Quick reference

- | | |
|--|---|
| <input checked="" type="checkbox"/> $BV \geq 40 V$ | <input checked="" type="checkbox"/> $R_{DS(ON)} \leq 1.0 m\Omega @ V_{GS} = 10 V$ |
| <input checked="" type="checkbox"/> $P_D \leq 96 W$ | |
| <input checked="" type="checkbox"/> $I_D \leq 250 A$ | |

2. Pin Description

| Pin | Description | Simplified Outline | Symbol |
|-------|-------------|--------------------|--------|
| 1,2,3 | Source | | |
| 4 | Gate | | |
| Tab | Drain | | |



Top View
TOLL-8L

3. Limiting Values

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------------------------------|--|--|-----|------|------|
| V _{DS} | Drain-Source Voltage | T _C =25°C | 40 | - | V |
| V _{GS} | Gate-Source Voltage | T _C =25°C | - | ±20 | V |
| I _D *, *** | Continuous Drain Current | T _C =25°C, V _{GS} =10 V | - | 250 | A |
| | | T _C =100°C, V _{GS} =10 V | - | 193 | A |
| I _{DM} *, **, *** | Pulsed Drain Current | T _C =25°C, V _{GS} =10 V | - | 1000 | A |
| E _{AS} | Single Pulsed Avalanche Energy | V _{DD} =40 V, L=0.3 mH | - | 1325 | mJ |
| P _D | Drain Power Dissipation | T _C =25°C | - | 96 | W |
| T _J , T _{stg} | Operating Junction and Storage Temperature Range | | -55 | 150 | °C |
| R _{θJA} * | Thermal Resistance-Junction to Ambient, Steady-State | | - | 50 | °C/W |
| R _{θJC} | Thermal Resistance-Junction to Case, Steady-State | | - | 1.3 | |

Notes:

* Surface mounted on minimum footprint pad area.

** Pulse width ≤ 300 μs, duty cycle ≤ 2%.

*** Limited by bonding wire.

4. Marking Information

| Product Name | Marking |
|--------------|-------------------------|
| KJ011N04LFH | KJ011N04LFH XXXXXX-X |

5. Ordering Code

| Product Name | Package | Reel size | Tape width | Quantity (pcs) |
|--------------|-----------|-----------|------------|----------------|
| KJ011N04LFH | LFPAK 5x6 | 13" | 12 mm | 5000 |

Note: KUAIJIEXIN defines "Green" as lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900 ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500 ppm by weight; Follow IEC 61249-2-21 and IPC/JEDEC J-STD-020C).

6. Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---|--------------------------------|--|-----|------|-----------|------------------|
| Static Characteristics | | | | | | |
| BV_{DSS} | Drain-Source Breakdown Voltage | $\text{V}_{\text{GS}}=0 \text{ V}, \text{I}_{\text{DS}}=1 \text{ mA}$ | 40 | - | - | V |
| $\text{V}_{\text{GS(TH)}}$ | Gate Threshold Voltage | $\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_{\text{DS}}=250 \mu\text{A}$ | 2 | 3 | 4 | V |
| I_{DSS} | Drain Leakage Current | $\text{V}_{\text{DS}}=40 \text{ V}, \text{V}_{\text{GS}}=0 \text{ V}$ | - | - | 1 | μA |
| I_{GSS} | Gate Leakage Current | $\text{V}_{\text{DS}}=0 \text{ V}, \text{V}_{\text{GS}}=\pm 20 \text{ V}$ | - | - | ± 100 | nA |
| $\text{R}_{\text{DS(ON)}}^{\text{a}}$ | On-State Resistance | $\text{V}_{\text{GS}}=10 \text{ V}, \text{I}_{\text{DS}}=30 \text{ A}$ | - | 0.88 | 1.0 | $\text{m}\Omega$ |
| g_{fs} | Forward transconductance | $\text{V}_{\text{GS}}=5 \text{ V}, \text{I}_{\text{DS}}=30 \text{ A}$ | - | 320 | - | S |
| R_g | Gate resistance | f=1 MHz, open drain | - | 0 | - | Ω |
| Diode Characteristics | | | | | | |
| $\text{V}_{\text{SD}}^{\text{a}}$ | Diode Forward Voltage | $\text{V}_{\text{GS}}=0 \text{ V}, \text{I}_{\text{SD}}=1 \text{ A}$ | - | - | 1.1 | V |
| t_{rr} | Reverse Recovery Time | $\text{V}_{\text{DS}}=20 \text{ V}, \text{I}_{\text{SD}}=30 \text{ A},$ $\text{dI}_{\text{SD}}/\text{dt}=100 \text{ A}/\mu\text{s}$ | - | 60 | - | ns |
| Q_{rr} | Reverse Recovery Charge | $\text{dI}_{\text{SD}}/\text{dt}=100 \text{ A}/\mu\text{s}$ | - | 100 | - | nC |
| Dynamic Characteristics ^b | | | | | | |
| C_{iss} | Input Capacitance | $\text{V}_{\text{DS}}=20 \text{ V}, \text{V}_{\text{GS}}=0 \text{ V},$ $f=1 \text{ MHz}$ | - | 7680 | - | pF |
| C_{oss} | Output Capacitance | | - | 1120 | - | |
| C_{rss} | Reverse Transfer Capacitance | | - | 595 | - | |
| $\text{t}_{\text{d(on)}}$ | Turn-on Delay Time | $\text{V}_{\text{DS}}=20 \text{ V}, \text{V}_{\text{GEN}}=10 \text{ V},$ $\text{R}_g=3 \Omega, \text{I}_{\text{DS}}=30 \text{ A}$ | - | 39 | - | ns |
| t_r | Turn-on Rise Time | | - | 33 | - | |
| $\text{t}_{\text{d(off)}}$ | Turn-off Delay Time | | - | 40 | - | |
| t_f | Turn-off Fall Time | | - | 18 | - | |
| Gate Charge Characteristics ^b | | | | | | |
| Q_g | Total Gate Charge | $\text{V}_{\text{DS}}=20 \text{ V}, \text{V}_{\text{GS}}=10 \text{ V},$ $\text{I}_{\text{DS}}=20 \text{ A}$ | - | 107 | - | nC |
| Q_{gs} | Gate-Source Charge | | - | 56 | - | |
| Q_{gd} | Gate-Drain Charge | | - | 26 | - | |

Notes:

- a. Pulse test; pulse width $\leq 300 \mu\text{s}$, duty cycle $\leq 2\%$.
- b. Guaranteed by design, not subject to production testing.

7. Typical Characteristics

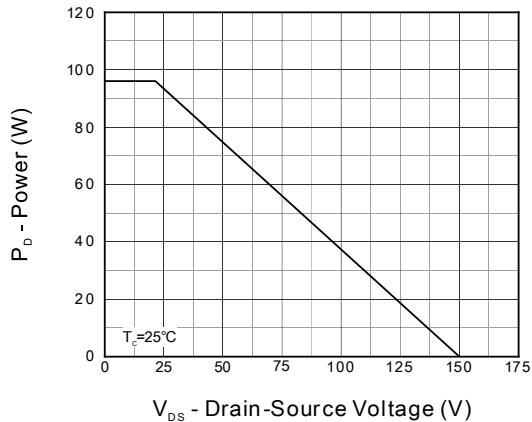


Figure 1. Output Characteristics

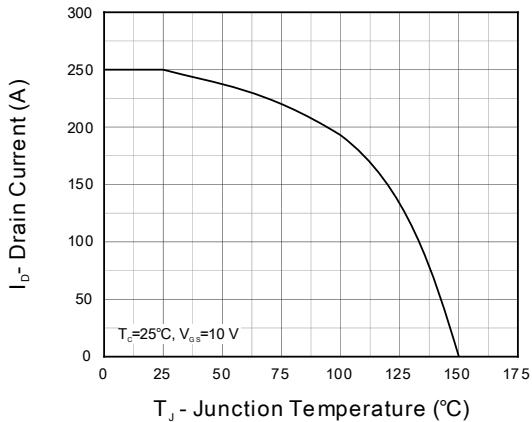


Figure 2. Current Capability

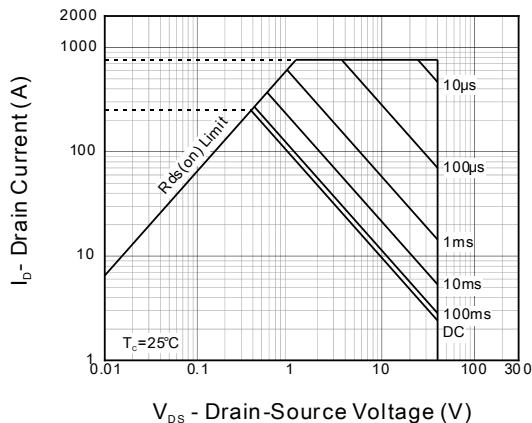


Figure 3. Safe Operation Area

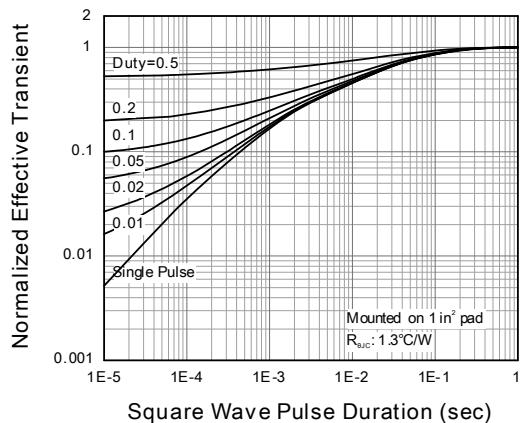


Figure 4. Transient Thermal Impedance

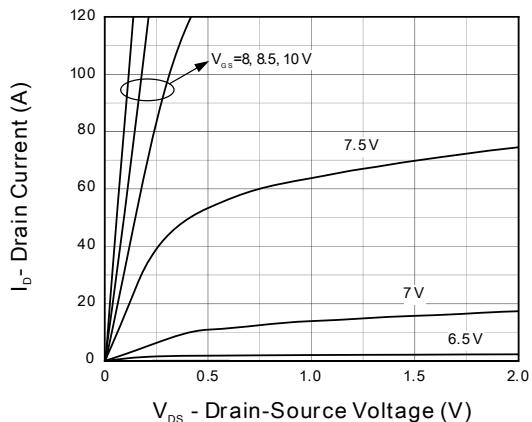


Figure 5. Output Characteristics

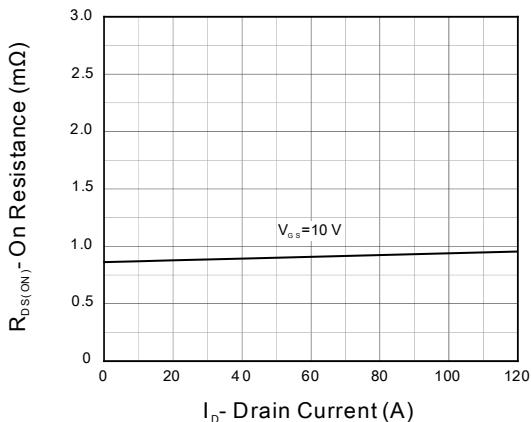


Figure 6. On Resistance

7. Typical Characteristics (cont.)

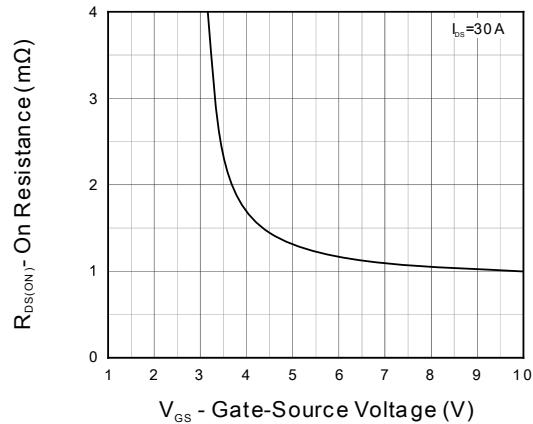


Figure 7. Transfer Characteristics

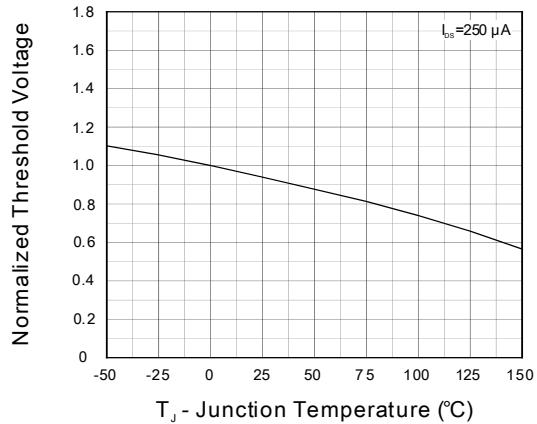


Figure 8. Normalized Threshold Voltage

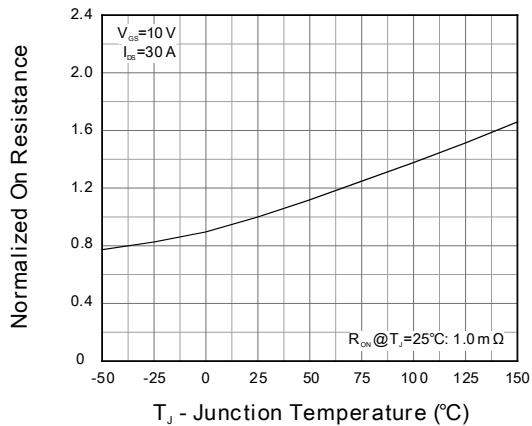


Figure 9. Normalized On Resistance

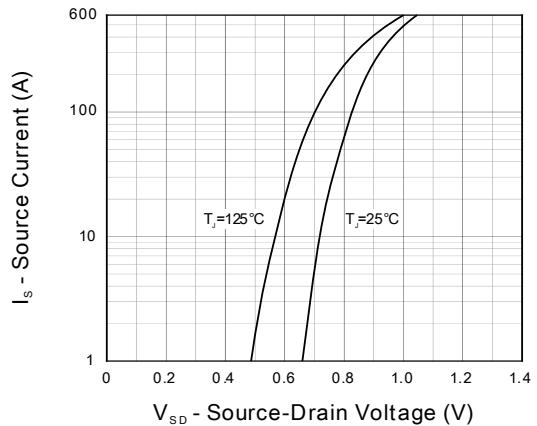


Figure 10. Diode Forward Current

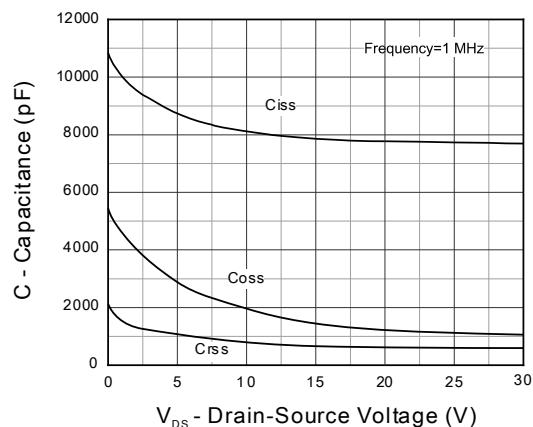


Figure 11. Capacitance

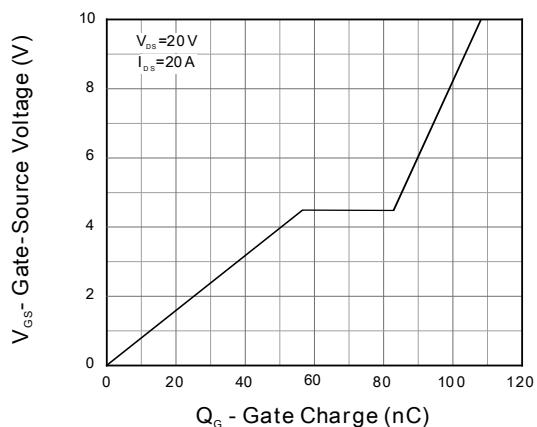
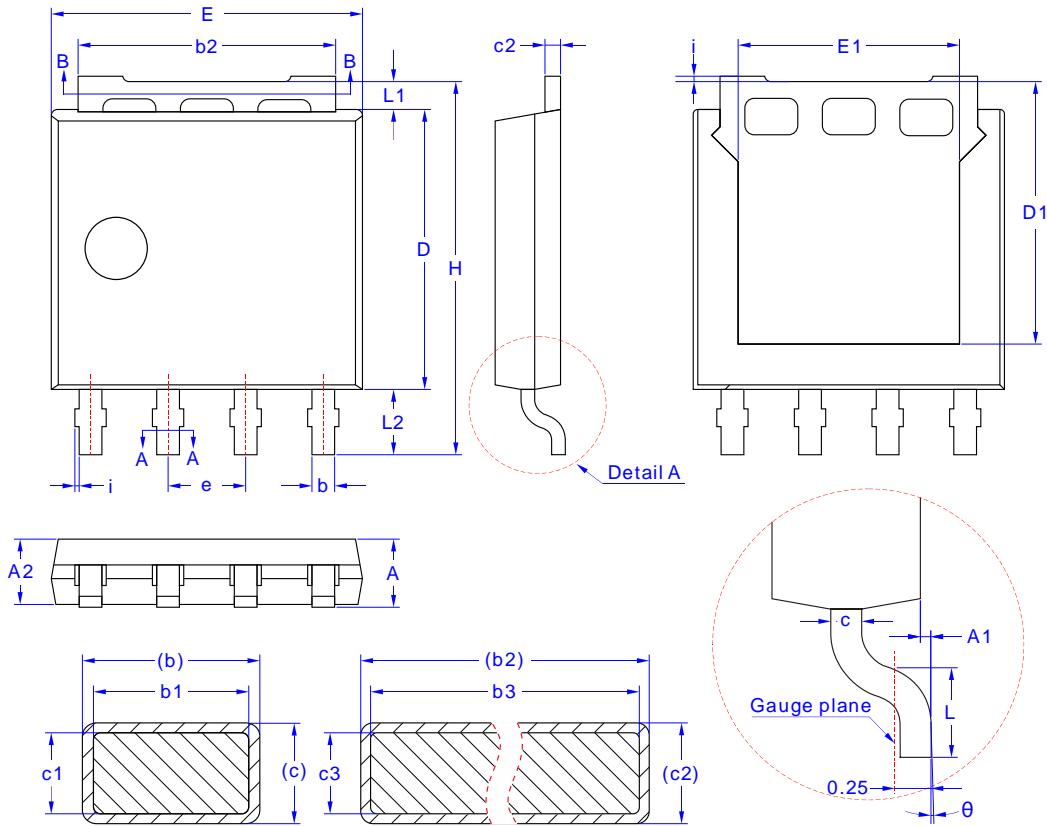


Figure 12. Gate Charge

8. Package Dimensions

LFPAK 5x6 Package



Section A-A

Section B-B

Detail A

| Symbol | Dimensions in Millimeters | |
|--------|---------------------------|------|
| | MIN | MAX |
| A | 1.00 | 1.30 |
| A1 | 0 | 0.15 |
| A2 | 0.98 | 1.12 |
| b | 0.35 | 0.50 |
| b1 | 0.32 | 0.46 |
| b2 | 4.02 | 4.41 |
| b3 | 4.00 | 4.37 |
| c | 0.19 | 0.25 |
| c1 | 0.17 | 0.23 |
| c2 | 0.24 | 0.30 |
| c3 | 0.22 | 0.28 |

| Symbol | Dimensions in Millimeters | |
|--------|---------------------------|------|
| | MIN | MAX |
| D | 4.45 | 4.70 |
| D1 | - | 4.45 |
| E | 4.95 | 5.30 |
| E1 | 3.50 | 3.70 |
| e | 1.27 BSC | |
| H | 5.95 | 6.25 |
| i | - | 0.25 |
| L | 0.40 | 0.85 |
| L1 | 0.27 | 0.57 |
| L2 | 0.80 | 1.30 |
| θ | 0° | 8° |